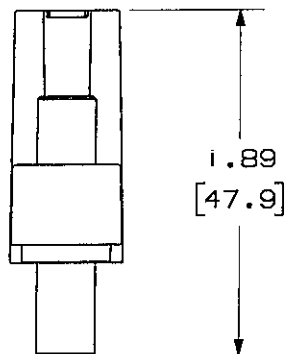


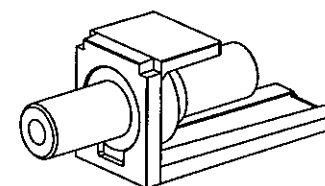
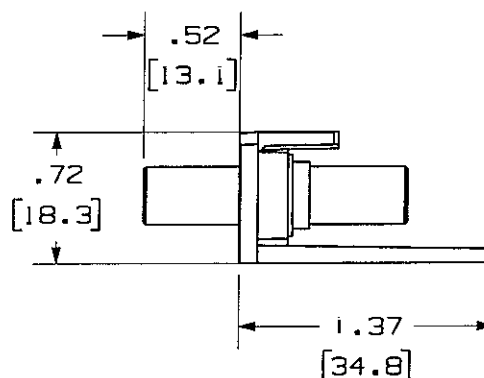
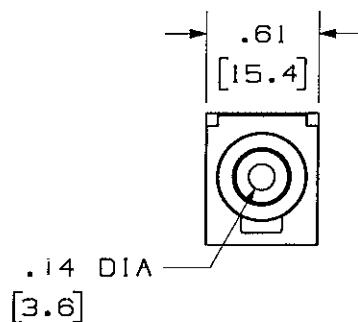
THIS COPY IS PROVIDED ON A RESTRICTED BASIS AND IS NOT TO BE USED IN ANY WAY DETRIMENTAL TO THE INTERESTS OF PANDUIT CORP.

PANDUIT P/N	WEIGHT
CM35MSC**Y	.08 LB/10 PCS (37.5 g/10 PCS)



NOTES:

1. SEE CURRENT CATALOG FOR ADDITIONAL PART NUMBER SUFFIXES TO INDICATE COLOR AND OR PACKAGE QUANTITY.
2. SEE CATALOG FOR COMPLETE LIST OF PARTS APPLICABLE FOR USE WITH THIS PART.
3. DIMENSIONS IN PARENTHESES ARE IN METRIC.
4. PART INCLUDES:
1- MODULE BASE
1- 3.5mm (1/8") HEAD PHONE JACK COUPLER (ASSEMBLED TO MODULE BASE)



NETWORK SYSTEMS

MAY 25 2006

ENGINEERING DEPT

MODEL FILENAME M02109AA_CM35MSC_00.PRT		SIZE A
DRAWING FILENAME M02479HF_DC190_00A.PRT		
MINI-COM 3.5mm (1/8") HEAD PHONE JACK COUPLER MODULE CUSTOMER DRAWING		
 PANDUIT ™ CORP. TINLEY PARK, ILL 60477	I.I. NUMBER	N/A
	PRODUCT SPEC	N/A
	WORK INSTRUCTION	N/A
	SCALE	NONE
 THIRD ANGLE PROJECTION	ALL DIMENSIONS ARE GIVEN IN INCHES, UNLESS OTHERWISE SPECIFIED. DIMENSIONAL TOLERANCES ARE: (.X) ± .010(.31) (.XX) ± .021(.81) ANGLES ±	
DRAWN BY JsP	MATERIAL: MODULE: ABS CONNECTOR: ZINC PLATED	
DATE 4-25-06	PART NO. CM35MSC**Y	
CHK'D MJP	DRAWING NO. 02479-190	

REV	DATE	BY	CHK	DESCRIPTION	ECN	R	CUST	SUP	OTH
R	4-25-06	JsP	MJP	RELEASED TO PRODUCTION	02479-190				